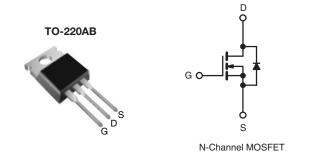


Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	40	400				
R _{DS(on)} (Ω)	V _{GS} = 10 V	3.6				
Q _g (Max.) (nC)	17	17				
Q _{gs} (nC)	3.4	3.4				
Q _{gd} (nC)	8.8	8.5				
Configuration	Sing	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF710PbF		
Leau (Fb)-nee	SiHF710-E3		
SnPb	IRF710		
SIFD	SiHF710		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	400		
Gate-Source Voltage			V _{GS}	± 20	V	
Continuous Duais Comment		T _C = 25 °C		2.0		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	1.2	Α	
Pulsed Drain Current ^a			I _{DM}	6.0		
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	120	mJ	
Repetitive Avalanche Current ^a			I _{AR}	2.0	А	
Repetitive Avalanche Energy ^a			E _{AR}	3.6	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P_{D}	36	W	
Peak Diode Recovery dV/dtc			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) for 10 s			-	300 ^d	7	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 52 mH, R_g = 25 Ω , I_{AS} = 2.0 A (see fig. 12).
- c. $I_{SD} \le 2.0$ A, $dI/dt \le 40$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.5		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.47	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} :	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 ^{\circ}\text{C}$		-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.2 A ^b	-	-	3.6	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 1.2 A ^b	1.0	=	-	S
Dynamic		-			l.	•	
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	170	-	pF
Output Capacitance	C _{oss}	1	$V_{DS} = 25 \text{ V},$	-	34	-	
Reverse Transfer Capacitance	C _{rss}	f = 1	f = 1.0 MHz, see fig. 5		6.3	-	
Total Gate Charge	Qg			-	-	17	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 2.0 \text{ A}, V_{DS} = 320 \text{ V}$ see fig. 6 and 13^b		-	3.4	
Gate-Drain Charge	Q_{gd}				-	8.5	
Turn-On Delay Time	t _{d(on)}		,		8.0	-	ns
Rise Time	t _r	$\begin{array}{c} {\rm V_{DD}} = 200 \; {\rm V, I_{D}} = 2.0 \; {\rm A,} \\ {\rm R_g} = 24 \; \Omega, {\rm R_{D}} = 95 \; \Omega \\ {\rm see \; fig. \; 10^b} \end{array}$		-	9.9	-	
Turn-Off Delay Time	t _{d(off)}			-	21	-	
Fall Time	t _f			ı	11	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- N.I.
Internal Source Inductance	L _S			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.0	^
Pulsed Diode Forward Current ^a	I _{SM}			-	-	6.0	- A
Body Diode Voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, \ I_S = 2.0 \text{A}, \ V_{GS} = 0 \text{V}^{\text{b}}$		-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 2.0 A, dl/dt = 100 A/μs ^b		-	240	540	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.85	1.6	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

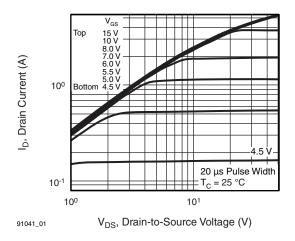


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

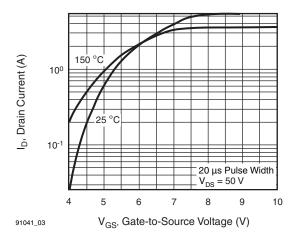


Fig. 3 - Typical Transfer Characteristics

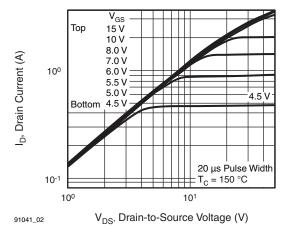


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

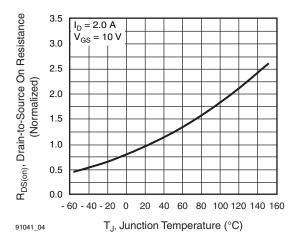
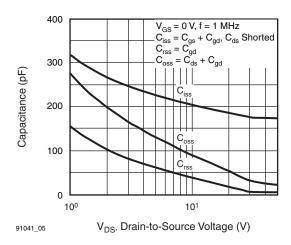


Fig. 4 - Normalized On-Resistance vs. Temperature





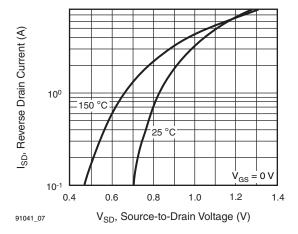


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage

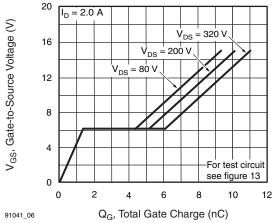


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

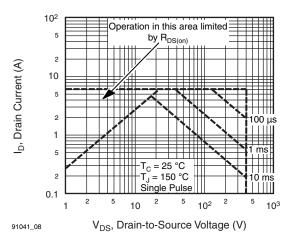


Fig. 8 - Maximum Safe Operating Area





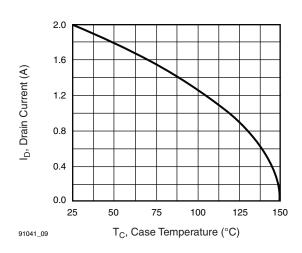


Fig. 9 - Maximum Drain Current vs. Case Temperature

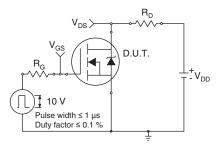


Fig. 10a - Switching Time Test Circuit

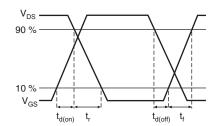


Fig. 10b - Switching Time Waveforms

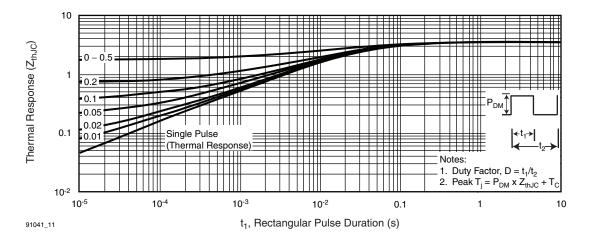


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



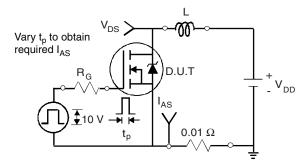


Fig. 12a - Unclamped Inductive Test Circuit

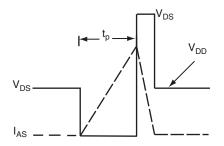


Fig. 12b - Unclamped Inductive Waveforms

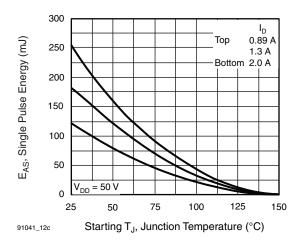


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

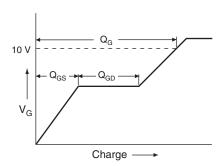


Fig. 13a - Basic Gate Charge Waveform

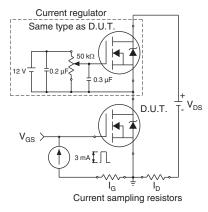
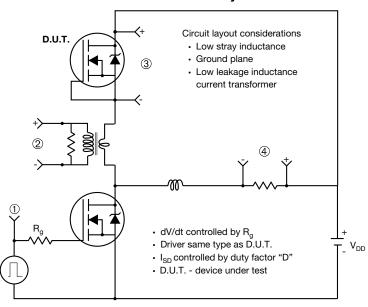


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



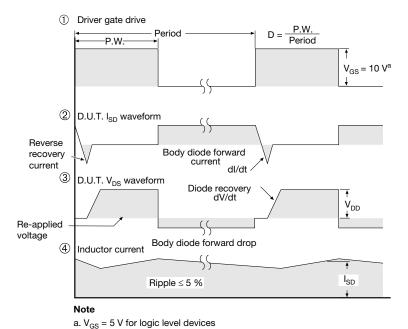


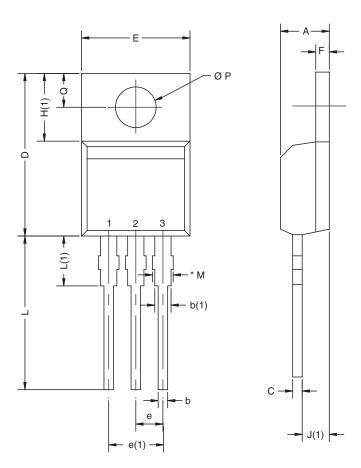
Fig. 14 - For N-Channel

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TO-220AB



	MILLIN	METERS	INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.25	4.65	0.167	0.183		
b	0.69	1.01	0.027	0.040		
b(1)	1.20	1.73	0.047	0.068		
С	0.36	0.61	0.014	0.024		
D	14.85	15.49	0.585	0.610		
Е	10.04	10.51	0.395	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.09	6.48	0.240	0.255		
J(1)	2.41	2.92	0.095	0.115		
L	13.35	14.02	0.526	0.552		
L(1)	3.32	3.82	0.131	0.150		
ØΡ	3.54	3.94	0.139	0.155		
Q	2.60	3.00	0.102	0.118		
ECN: X10-0416-Rev. M, 01-Nov-10						

DWG: 5471

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM





Vishay

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